Product Features

- High dynamic range downconverter with integrated LO and IF amplifiers
- Dual channels for diversity
- +28 dBm Input IP3
- +9 dBm Input P1dB
- RF: 1900 2400 MHz
- IF: 65 300 MHz
- +5V Single supply operation
- RoHS-compliaint / Pb-free 6x6mm 28-pin QFN package
- Low-side LO configuration

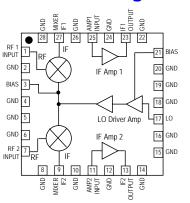
Product Description

The CV221-2A is a dual-channel high-linearity downconverter designed to meet the demanding performance, functionality, and cost goals of current and next generation mobile infrastructure basestations and repeaters. provides high dynamic range performance in a low profile RoHS-compliant/lead-free surface-mount leadless package that measures 6 x 6 mm square.

It is ideally suited for high dynamic range receiver front ends using diversity receive channels. Functionality includes frequency conversion and IF amplification, while an integrated LO driver amplifier powers the passive mixer. The MCM is implemented with reliable and mature GaAs MESFET and InGaP HBT technology.

Typical applications include frequency downconversion used in W-CDMA and WiBro 2.5G and 3G basestation transceiver or repeater applications.

Functional Diagram



Specifications (1)

Parameters	Units	Min	Тур	Max	Comments
RF Frequency Range	MHz		1900 - 2400		
LO Frequency Range	MHz		1600 - 2335		
IF Frequency Range	MHz		65 - 300		See note 2
% Bandwidth around IF center frequency	%		±7.5		See note 3
IF Test Frequency	MHz		240		
SSB Conversion Gain	dB	6.5	9.2	10.5	Temp = 25 °C
Gain Drift over Temp (-40 to 85 °C)	dB		±0.6		Referenced to +25 °C
Input IP3	dBm	+24	+28		See note 4
Input 1 dB Compression Point	dBm		+9		See note 4
Noise Figure	dB		11		See note 5
LO Input Drive Level	dBm	-2.5	0	+2.5	
LO-RF Isolation	dB		12		$P_{LO} = 0 \text{ dBm}$
LO-IF Isolation	dB		26		$P_{LO} = 0 \text{ dBm}$
RF-IF Isolation	dB		25		
Branch-Branch Isolation	dB		45		
Return Loss: RF Port	dB		14		
Return Loss: LO Port	dB		14		
Return Loss: IF Port	dB		13		
Operating Supply Voltage	V		+5		
Supply Current	mA		315	330	See note 6
Thermal Resistance	°C / W			34	
Junction Temperature	°C			160	See note 6

Specifications when using the application specific circuit (shown on page 3) with a low side LO = 0 dBm and IF = 240 MHz in a downconverting application at 25 °C.

Absolute Maximum Rating

Parameter	Rating
Operating Case Temperature	-40 to +85 °C
Storage Temperature	-55 to +150 °C
DC Voltage	+5.5 V
Junction Temperature	+220 °C

Ordering Information

Part No.	Description
CV221-2AF	UMTS-band Dual-Branch Downconverter (lead-free/RoHS-compliant 6x6mm QFN package)
CV221-2APCB240	Fully Assembled Eval. Board, IF = 240MHz

Specifications and information are subject to change without notice

IF matching components affect the center IF frequency. Proper component values for other IF center frequencies than shown can be provided by emailing to applications.engineering@wj.com.

The IF bandwidth of the converter is defined as 15% around any center frequency in its operating IF frequency range. The bandwidth is determined with external components. Specifications are valid around the total $\pm 7.5\%$ bandwidth. ie. with a center frequency of 240 MHz, the specifications are valid from 240 ± 18 MHz.

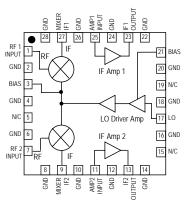
Assumes the supply voltage = +5 V. IIP3 is measured with $\Delta f = 1$ MHz with RFin = -5 dBm / tone.

Assumes LO injection noise is filtered at the thermal noise floor, -174 dBm/Hz, at the RF, IF, and Image frequencies.

The R1 resistor can be modified for the CV221-2A to draw less current. Changing it from 13 to 18Ω is expected to have the converter draw 17mA less current so that the converter will draw about 300mA typically under LO drive, while degrading the IIP3 performance by 0.5 dB.

Operation of this device above any of these parameters may cause permanent damage

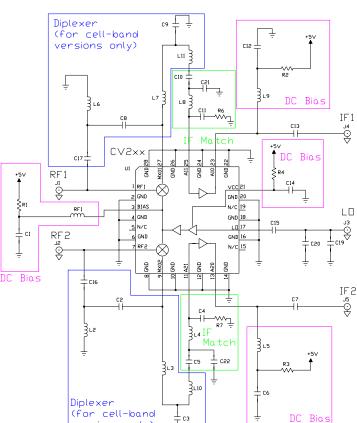
Device Architecture / Application Circuit Information



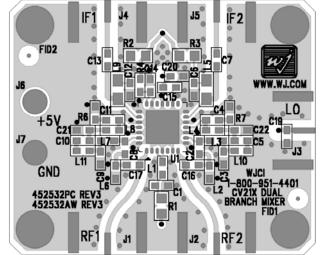
Typical Downconverter Performance Chain Analysis (Each Branch)

	. Input		Input			Cumulative Performance			
Stage	Gain (dB)	P1dB (dBm)	IP3 (dBm)	NF (dB)	Current (mA)	Gain (dB)	Input P1dB (dBm)	Input IP3 (dBm)	NF (dB)
LO Amp / MMIC Mixer	-8.4	20	33	9	115	-8.4	20	33	9
IF Amplifier	17.6	1	21	2.2	100	9.2	9	27.8	11
CV221-2A	Cu	Cumulative Performance			315*	9.2	9	27.8	11

* The 2nd branch includes another mixer and IF amplifier, which increases the total current consumption of the MCM to be 315 mA.



Printed Circuit Board Material: .014" FR-4, 4 layers, .062" total thickness



CV221-2A: The application circuit can be broken up into three main functions as denoted in the colored dotted areas above: RF/IF diplexing (blue), IF amplifier matching (green), and dc biasing (purple). There are various placeholders for chip components in the circuit schematic so that a common PCB can be used for all WJ dual-branch converters.

versions only)

External Diplexer: This is only used with the cellular-band CV products. The mixer performs the diplexing internally for the CV221-2A; therefore the components shown in the diplexer section should be not be loaded except for L3, L10, L7, and L11, which should contain a $0~\Omega$ jumper.

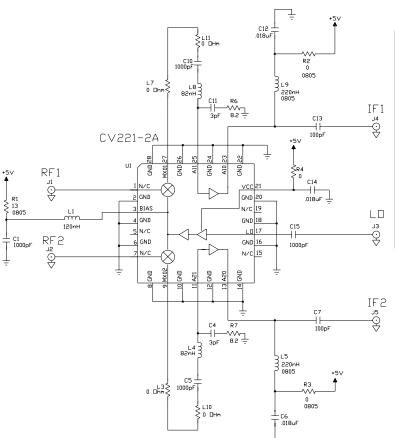
IF Amplifier Matching: The IF amplifier requires matching elements to optimize the performance of the amplifier to the desired IF center frequency. Since IF bandwidths are typically on the order

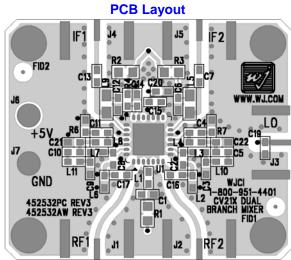
of 5 to 10%, a simple two element matching network, in the form of either a high-pass or low-pass filter structure, is sufficient to match the MMIC IF amplifier over these narrow bandwidths. Proper component values for other IF center frequencies can be provided by emailing to applications.engineering@wj.com.

DC biasing: DC bias must be provided for the LO and IF amplifiers in the converter. R1 sets the operating current for the last stage of the LO amplifier and is chosen to optimize the mixer LO drive level. Proper RF chokes and bypass capacitors are chosen for proper amplifier biasing at the intended frequency of operation. The "+5 V" dc bias should be supplied directly from a voltage regulator.

Specifications and information are subject to change without notice

Application Circuit: IF = 240 MHz (CV221-2APCB240) RF = 1900 - 2200 MHz, IF = 240 MHz





Circuit Board Material: .014" FR-4, 4 layers, .062" total thickness

Bill of Materials

Ref. Desig.	Component	Size
R1 ⁽¹⁾	13 Ω chip resistor	0805
R2, R3, R4, L3, L7 L10, L11	0 Ω chip resistor	0603
R6, R7	8.2 Ω chip resistor	0603
C1, C5, C10, C15	1000 pF chip capacitor	0603
C4, C11 (2)	3 pF chip capacitor	0603
C6, C12, C14	.018 μF chip capacitor	0603
C7, C13	100 pF chip capacitor	0603
L1	120 nH chip inductor	0603
L4, L8 ⁽²⁾	82 nH chip inductor	0603
L5, L9	220 nH chip inductor	0805
C2, C3, C8, C9, C16 C17, C19, C20, C21 C22, L2, L6	Shown on silkscreen, but not used in actual circuit.	
U1	CV221-2A WJ Converter	QFN

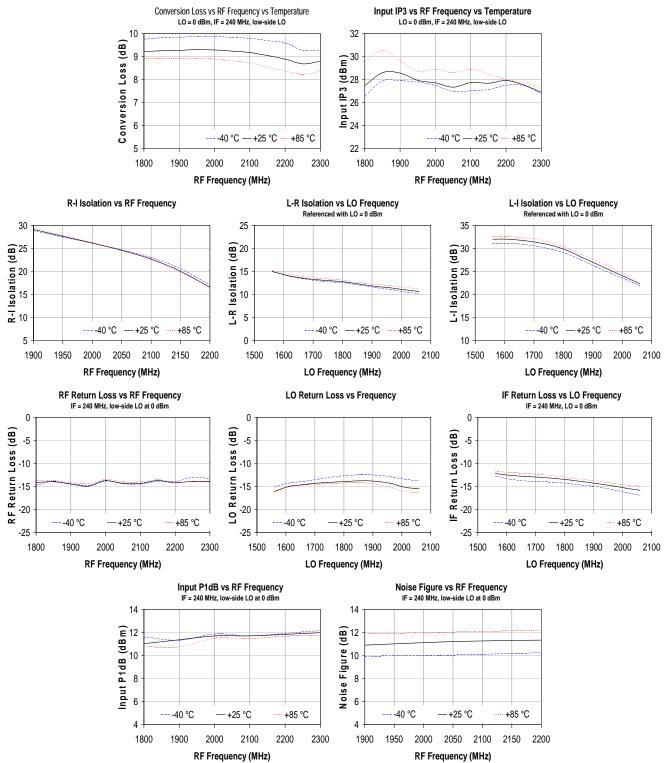
Notes:

- 1. The R1 resistor can be modified for the CV221-2A to draw less current. Changing it from 13 to 18Ω is expected to have the converter draw 17mA less current so that the converter will draw about 300mA typically under LO drive, while degrading the IIP3 performance by 0.5 dB.
- 2. The values shown above have the IF tuned at 240 MHz and will affect the optimal performance of the converter. For other frequencies, these components need to be modified as follows:

	IF Center Frequency (MHz)						
Ref. Desig.	70	75	100	120	140	240	
C4, C11	15 pF	15 pF	8.2 pF	8.2 pF	5.6 pF	3 pF	
L4, L8	220 nH	220 nH	180 nH	150 nH	150 nH	82 nH	

Typical Downconversion Performance Plots Performance using the circuitry on the CV221-24 PCR240 Evaluation Board

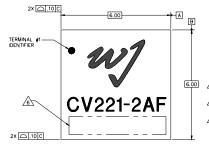
Performance using the circuitry on the CV221-2APCB240 Evaluation Board



CV221-2AF Mechanical Information

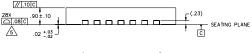
This package is lead-free/RoHS-compliant. The plating material on the pins is annealed matte tin over copper. It is compatible with both lead-free (maximum 260 °C reflow temperature) and leaded (maximum 245 °C reflow temperature) soldering processes.

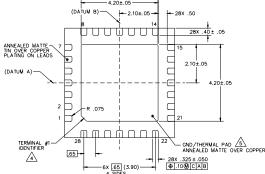
Outline Drawing



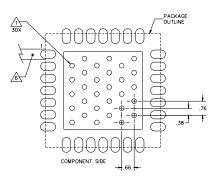
- EXCEPT WHERE NOTED, THIS PART OUTLINE CONFO TO JEDEC STANDARD MO-220, ISSUE E (VARIATIO VJJC) FOR THERMALLY ENHANCED PLASTIC VERY FINE PITCH QUAD FLAT NO LEAD PACKAGE (QFN).
- DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.4M-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.

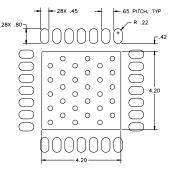
- ALPHA-NUMERIC LOT CODE.

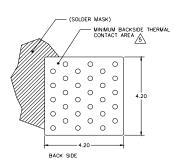




Mounting Configuration / Land Pattern







NOTES

- GROUND/THERMAL WAS ARE CRITICAL FOR THE PROPER PERFORMANCE OF THIS DEVICE. WAS SHOULD USE A .35mm (#80/.0135") DIAMETER DRILL AND HAVE A FINAL, PLATED THRU DIAMETER OF .25mm (.010"). ⚠
- ADD AS MUCH COPPER AS POSSIBLE TO INNER AND OUTER LAYERS NEAR THE PART TO ENSURE OPTIMAL THERMAL PERFORMANCE.
- TO ENSURE RELIABLE OPERATION, DEVICE GROUND PADDLE-TO-GROUND PAD SOLDER JOINT IS CRITICAL.
- ADD MOUNTING SCREWS NEAR THE PART TO FASTEN THE BOARD TO A HEATSINK. ENSURE THAT THE GROUND/THERMAL VIA REGION CONTACTS THE HEATSINK

DO NOT PUT SOLDER MASK ON THE BACK SIDE OF THE PC BOARD IN THE REGION WHERE THE BOARD CONTACTS THE HEATSINK.

- RF TRACE WIDTH DEPENDS UPON THE PC BOARD MATERIAL AND CONSTRUCTION.
- USE 1 OZ. COPPER MINIMUM.
- ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES

Product Marking

The component will be lasermarked with a "CV221-2AF" product label with alphanumeric lot code on the top surface of the package.

Tape and reel specifications for this part will be located on the website in the "Application Notes" section.

ESD / MSL Information



Caution! ESD sensitive device.

ESD Rating: Class 1B

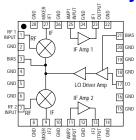
Passes $\geq 500V$ to <1000VValue: Human Body Model (HBM) Test: JEDEC Standard JESD22-A114 Standard:

ESD Rating: Class III

Passes ≥ 500V to <1000V Value: Test: Charged Device Model (CDM) JEDEC Standard JESD22-C101 Standard:

MSL Rating: Level 2 at +260 °C convection reflow JEDEC Standard J-STD-020 Standard:

Functional Pin Layout



		0	
Pin	Function	Pin	Function
1	Ch. 1 Mixer RF Input	15	N/C or GND
3	LO Amp Bias	17	LO input
5	N/C or GND	19	N/C or GND
7	Ch. 2 Mixer RF Input	21	+5 V
9	Ch. 2 Mixer IF Output	23	Ch. 1 IF Amp Output / Bias
11	Ch. 2 IF Amp Input	25	Ch. 1 IF Amp Input
13	Ch. 2 IF Amp Output / Bias	27	Ch. 1 Mixer IF Output

The even numbered pins are hard grounded to the backside paddle internally. They can be grounded or not connected. The backside paddle is required to be grounded.